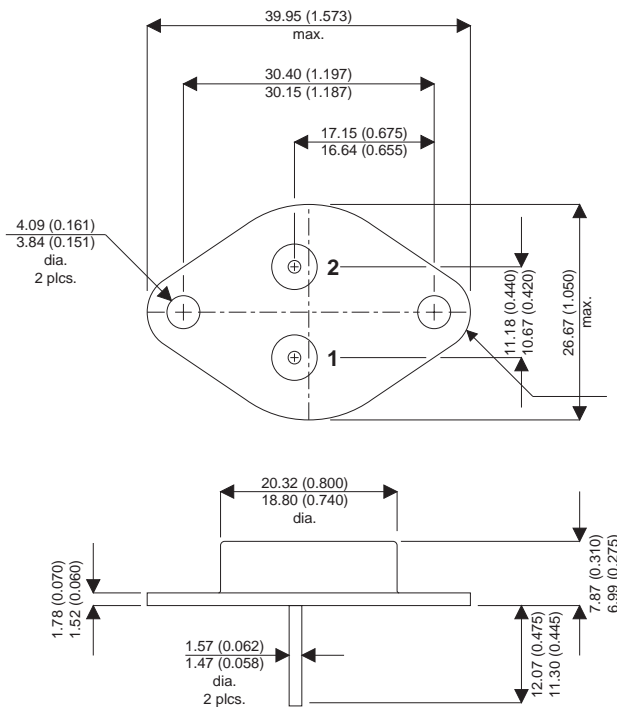


MECHANICAL DATA

Dimensions in mm (inches)



**N-CHANNEL
POWER MOSFET**

V_{DSS} **60V**
 $I_{D(cont)}$ **44A**
 $R_{DS(on)}$ **0.028Ω**

FEATURES

- HERMETICALLY SEALED TO-3 METAL PACKAGE
- SIMPLE DRIVE REQUIREMENTS
- SCREENING OPTIONS AVAILABLE

TO-3 Metal Package

Pin 1 – Gate Pin 2 – Source Case – Drain

ABSOLUTE MAXIMUM RATINGS ($T_{case} = 25^{\circ}C$ unless otherwise stated)

V_{GS}	Gate – Source Voltage	$\pm 20V$
I_D	Continuous Drain Current ($V_{GS} = 0, T_{case} = 25^{\circ}C$)	44A
I_D	Continuous Drain Current ($V_{GS} = 0, T_{case} = 100^{\circ}C$)	27A
I_{DM}	Pulsed Drain Current ¹	176A
P_D	Power Dissipation @ $T_{case} = 25^{\circ}C$	125W
	Linear Derating Factor	1.0W/ $^{\circ}C$
E_{AS}	Single Pulse Avalanche Energy ²	340mJ
dv/dt	Peak Diode Recovery ³	4.5V/ns
T_J, T_{stg}	Operating and Storage Temperature Range	-55 to 150 $^{\circ}C$
T_L	Lead Temperature 1.6mm (0.63") from case for 10 sec.	300 $^{\circ}C$

Notes

- 1) Pulse Test: Pulse Width $\leq 300\mu s, \delta \leq 2\%$
- 2) @ $V_{DD} = 25V, L \geq 200\mu H, R_G = 25\Omega, Peak I_L = 44A, Starting T_J = 25^{\circ}C$
- 3) @ $I_{SD} \leq 44A, di/dt \leq 250A/\mu s, V_{DD} \leq BV_{DSS}, T_J \leq 150^{\circ}C, Suggested R_G = 9.1\Omega$

ELECTRICAL CHARACTERISTICS ($T_{\text{case}} = 25^{\circ}\text{C}$ unless otherwise stated)

Parameter	Test Conditions	Min.	Typ.	Max.	Unit
STATIC ELECTRICAL RATINGS					
BV_{DSS} Drain – Source Breakdown Voltage	$V_{\text{GS}} = 0$ $I_{\text{D}} = 1\text{mA}$	60			V
$\Delta BV_{\text{DSS}} / \Delta T_{\text{J}}$ Temperature Coefficient of Breakdown Voltage	Reference to 25°C $I_{\text{D}} = 1\text{mA}$		0.68		$\text{V}/^{\circ}\text{C}$
$R_{\text{DS(on)}}$ Static Drain – Source On–State Resistance ¹	$V_{\text{GS}} = 10\text{V}$ $I_{\text{D}} = 27\text{A}$			0.028	Ω
	$V_{\text{GS}} = 10\text{V}$ $I_{\text{D}} = 44\text{A}$			0.032	
$V_{\text{GS(th)}}$ Gate Threshold Voltage	$V_{\text{DS}} = V_{\text{GS}}$ $I_{\text{D}} = 250\text{mA}$	2		4	V
g_{fs} Forward Transconductance ¹	$V_{\text{DS}} \geq 15\text{V}$ $I_{\text{DS}} = 27\text{A}$	17			S ($\bar{\cup}$)
I_{DSS} Zero Gate Voltage Drain Current	$V_{\text{GS}} = 0$ $V_{\text{DS}} = 0.8BV_{\text{DSS}}$ $T_{\text{J}} = 125^{\circ}\text{C}$			25	μA
				250	
I_{GSS} Forward Gate – Source Leakage	$V_{\text{GS}} = 20\text{V}$			100	nA
I_{GSS} Reverse Gate – Source Leakage	$V_{\text{GS}} = -20\text{V}$			-100	
DYNAMIC CHARACTERISTICS					
C_{iss} Input Capacitance	$V_{\text{GS}} = 0$		2400		pF
C_{oss} Output Capacitance	$V_{\text{DS}} = 25\text{V}$		1100		
C_{riss} Reverse Transfer Capacitance	$f = 1\text{MHz}$		230		
Q_{g} Total Gate Charge	$V_{\text{GS}} = 10\text{V}$	39		88	nC
Q_{gs} Gate – Source Charge	$I_{\text{D}} = 44\text{A}$	6.7		15	
Q_{gd} Gate – Drain (“Miller”) Charge	$V_{\text{DS}} = 0.5BV_{\text{DSS}}$	18		52	
$t_{\text{d(on)}}$ Turn–On Delay Time	$V_{\text{DD}} = 30\text{V}$ $I_{\text{D}} = 44\text{A}$ $R_{\text{G}} = 9.1\Omega$			23	ns
t_{r} Rise Time				130	
$t_{\text{d(off)}}$ Turn–Off Delay Time				81	
t_{f} Fall Time				79	
SOURCE – DRAIN DIODE CHARACTERISTICS					
I_{S} Continuous Source Current				44	A
I_{SM} Pulse Source Current ²				176	
V_{SD} Diode Forward Voltage ¹	$I_{\text{S}} = 44\text{A}$ $T_{\text{J}} = 25^{\circ}\text{C}$ $V_{\text{GS}} = 0$			2.5	V
t_{rr} Reverse Recovery Time	$I_{\text{F}} = 44\text{A}$ $T_{\text{J}} = 25^{\circ}\text{C}$			220	ns
Q_{rr} Reverse Recovery Charge ¹	$d_{\text{i}} / d_{\text{t}} \leq 100\text{A}/\mu\text{s}$ $V_{\text{DD}} \leq 50\text{V}$			1.6	μC
t_{on} Forward Turn–On Time		Negligible			
PACKAGE CHARACTERISTICS					
L_{D} Internal Drain Inductance (measured from 6mm down drain lead to centre of die)			5.0		nH
L_{S} Internal Source Inductance (from 6mm down source lead to source bond pad)			13		
THERMAL CHARACTERISTICS					
$R_{\theta\text{JC}}$ Thermal Resistance Junction – Case				1.0	$^{\circ}\text{C}/\text{W}$
$R_{\theta\text{CS}}$ Thermal Resistance Case – Sink			0.12		
$R_{\theta\text{JA}}$ Thermal Resistance Junction – Ambient				30	

Notes

- 1) Pulse Test: Pulse Width $\leq 300\text{ms}$, $\delta \leq 2\%$
- 2) Repetitive Rating – Pulse width limited by maximum junction temperature.